



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

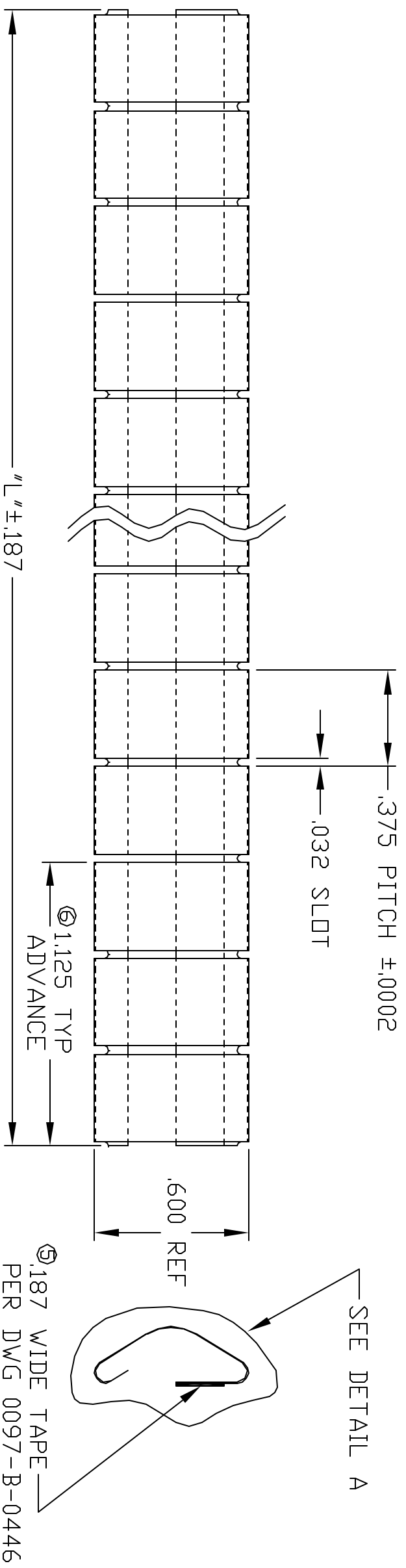
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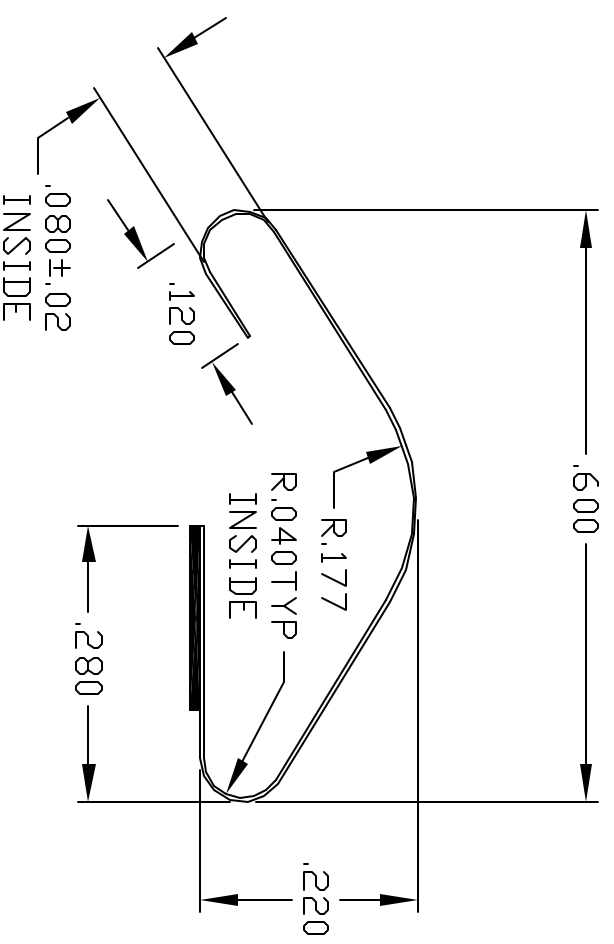
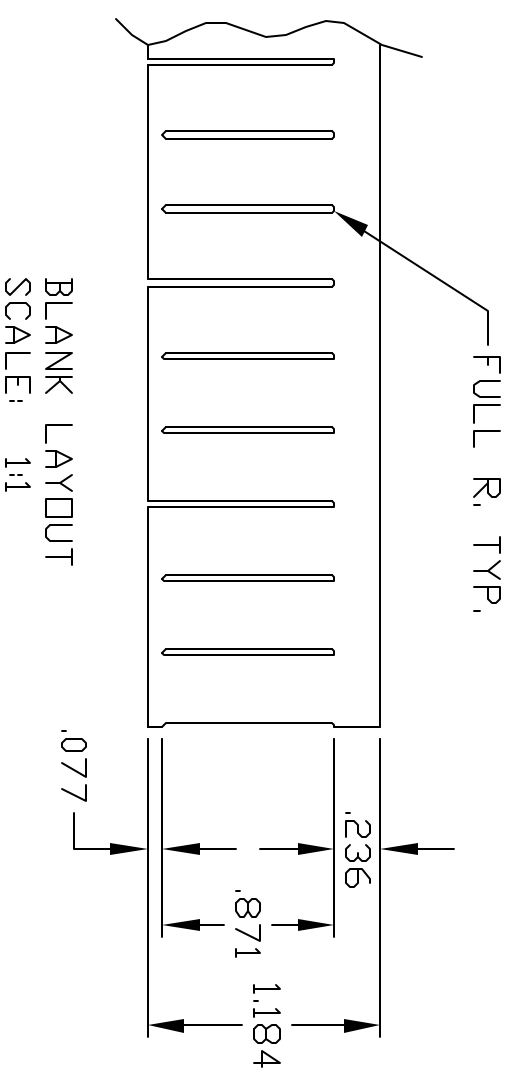
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



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DWG. NO.	0077-0014-00	
ECN 6854 REVISED DPS.		02
MN 5-5-92 EWS 5-5-92		
ECN 6974 REVISED DPS.		03
MN 5-6-92 EWS 5-6-92		
ECN 6997 REVISED DPS.		04
MN 7-30-92 KS 7-30-92		
ECN 9095 .187 WIDE TAPE WAS		05
250, BW 5-3-94 EWS 5-3-94		
ECN-E1191 ADDED 1.125 DIMENSION,		
CHANGED MAT'L WIDTH,		
RKM 9-24-99. EWS 9-24-99		06
ECN-E1401 ADDED TABULATED		
DASH TABLE.		
RKM 12-22-99. EWS 12-22-99		07
ECN-E1465 ADDED 'L' COLUMN TO		
DASHED TABLE.		
RKM 1-31-00. EWS 1-31-00		08
ECN-E1808 DELETED -99 PART,		
RKM 7-31-00. EWS 7-31-00		09
ECN-E2400 UPDATED TO CURRENT		
FORMAT, RKM 07/10/01.		
EWS 7-23-01		10



DETAIL A

MATERIAL:		⑤ .0035±.00015 X 1.370±.003 BeCu ALLOY 25 - 1/2 HARD	
HEAT TREATED:		TD DPH 383 MIN. USING A 500 GRAM LOAD	
THICKNESS AFTER:		CLEANING AND BEFORE PLATING: .0032 MIN.	
FINISH:		AS REQUIRED	
TOLERANCES NOT SHOWN		DECIMAL 2 PL'S ± DECIMAL 3 PL'S ± .010	
THIRD ANGLE PROJECTION		ANGULAR ±	
UNITS:		INCH [SCALE] [MM]	
SCALE:		2:1	
METHOOD		"L"	
PROGRESSIVE DIE		23.625	
DRAWN BY:		RCC	
DATE:		09/18/91	
CHECKED BY:		TS	
DATE:		10/30/91	
APPROVED BY:		TS	
DATE:		10/30/91	
DRAWN BY:		RCC	
DATE:		09/18/91	
CHECKED BY:		TS	
DATE:		10/30/91	
APPROVED BY:		TS	
DATE:		10/30/91	
REF. DWG NO.:			
DWG. NO.:		0077-0014-00	
SUB		10	

DWG. NO. 0077-0014-00

CAD MAINTAINED DRAWING. MANUAL CHANGES UNAUTHORIZED.

DWG. NO. 0077-0014-00 SUB 10